BPX 38

Metal Can® TO18

Silicon NPN Phototransistor





Applications

 Industrial Automation (Machine Controls, Light Barriers, Vision Controls)

Features:

- Package: hermetically sealed
- Spectral range of sensitivity: (typ) 450 ... 1120 nm
- Base connection
- Suitable up to 125 °C
- High linearity
- Available in groups

Ordering Information

Туре	Photocurrent V_{CE} = 5 V; λ = 950 nm; E_{e} = 0.5 mW/cm ² I_{PCE}	Ordering Code
BPX 38	200 1000 μA	Q62702P0015
BPX 38-3	320 630 μA	Q62702P0015S003
BPX 38-4	500 1000 μA	Q62702P0015S004
BPX 38-2/3	200 630 μΑ	Q62702P3578

Only one bin within one packing unit (variation less than 2:1)



Mayi	DOLLIDO.		inac
IVIAXI	mum	Rai	IIIUS

T_A = 25 °C

A 20 0			
Parameter	Symbol		Values
Operating temperature	T _{op}	min.	-40 °C
	σp	max.	125 °C
Storage temperature	T _{stg}	min.	-40 °C
	0.9	max.	125 °C
Collector-emitter voltage	V_{CE}	max.	50 V
Collector current	I _c	max.	50 mA
Collector surge current	I _{cs}	max.	200 mA
τ ≤ 10 μs			
Emitter-basis voltage	$V_{\sf EB}$	max.	7 V
Total power dissipation	P _{tot}	max.	220 mW



Characteristics

T_A = 25 °C

Parameter	Symbol		Values
Wavelength of max sensitivity	$\lambda_{_{ extsf{S max}}}$	typ.	880 nm
Spectral range of sensitivity	\(\lambda_{10\%}\)	typ.	450 1120 nm
Dimensions of chip area	LxW	typ.	1.02 x 1.02 mm x mm
Radiant sensitive area	А	typ.	0.675 mm ²
Half angle	φ	typ.	40 °
Photocurrent $V_{CE} = 5 \text{ V}$; Std. Light A; $E_v = 1000 \text{ lx}$	I _{PCE}	typ.	1900 μΑ
Photocurrent of collector-base photodiode $E_e = 0.5 \text{ mW/cm}^2$; $\lambda = 950 \text{ nm}$; $V_{CB} = 5 \text{ V}$	l _{PCB}	typ.	1.8 μΑ
Photocurrent of collector-base photodiode $E_v = 1000 \text{ lx}$; Std. Light A; $V_{CB} = 5 \text{ V}$	I _{PCB}	typ.	5.5 µA
Dark current V _{CE} = 25 V; E = 0	I _{CE0}	typ. max.	20 nA 100 nA
Rise time $I_c = 1 \text{ mA}$; $V_{cc} = 5 \text{ V}$; $R_L = 1 \text{ k}\Omega$	t _r	typ.	12 µs
Fall time $I_c = 1 \text{ mA}$; $V_{cc} = 5 \text{ V}$; $R_L = 1 \text{ k}\Omega$	t _f	typ.	12 µs
Collector-emitter saturation voltage $^{1)}$ $I_{\rm C} = I_{\rm PCE,min} \times 0.3$; $E_{\rm e} = 0.5 \rm mW/cm^2$	V_{CEsat}	typ.	200 mV
Capacitance $V_{CE} = 0 \text{ V}; f = 1 \text{ MHz}; E = 0$	C _{CE}	typ.	23 pF
Capacitance $V_{CB} = 0 \text{ V}; f = 1 \text{ MHz}; E = 0$	С _{СВ}	typ.	39 pF
Capacitance $V_{EB} = 0 \text{ V}; f = 1 \text{ MHz}; E = 0$	C_{EB}	typ.	47 pF
Thermal resistance junction ambient real	R_{thJA}	max.	450 K / W



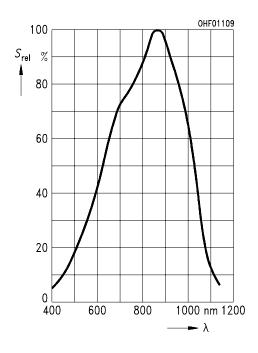
Photocurrent Groups

 $T_A = 25$ °C

Group	Photocurrent V_{CE} = 5 V; λ = 950 nm; E_{e} = 0.5 mW/cm² min. I_{PCE}	Photocurrent $V_{CE} = 5 \text{ V}; \lambda = 950 \text{ nm}; E_{e} = 0.5 \text{ mW/cm}^{2}$ max. I_{PCE}
2	200 μΑ	400 μA
3	320 μΑ	630 µA
4	500 μΑ	1000 μΑ

Relative Spectral Sensitivity 2), 3)

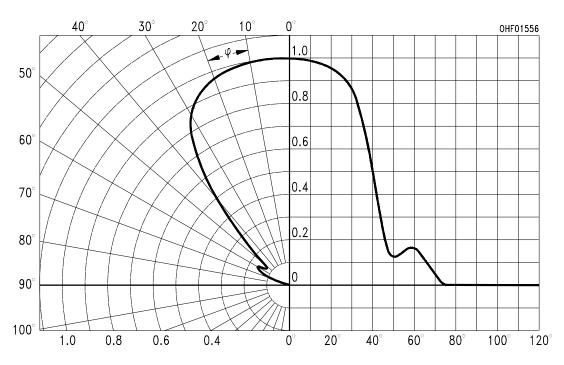
$$S_{rel} = f(\lambda)$$





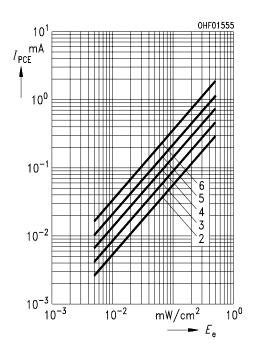
Directional Characteristics 2), 3)

$$S_{rel} = f(\phi)$$



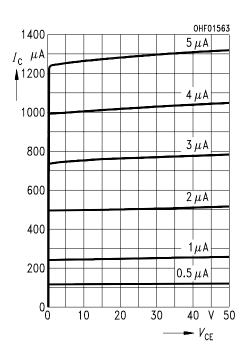
Photocurrent 2), 3)

$$I_{PCE} = f(E_e)$$
; $V_{CE} = 5 V$



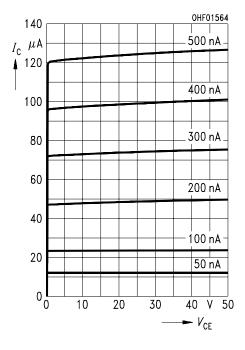
Collector Current 2), 3)

$$I_{CE} = f(V_{CE}); I_{B} = Parameter$$



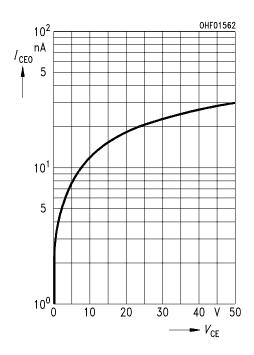
Collector Current 2), 3)

 $I_{CE} = f(V_{CE}); I_{B} = Parameter$



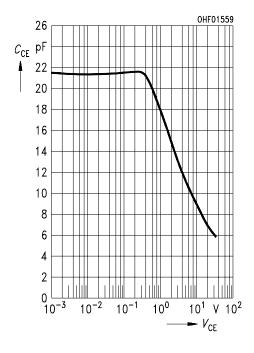
Dark Current 2), 3)

 $I_{CE0} = f(V_{CE})$; E = 0;



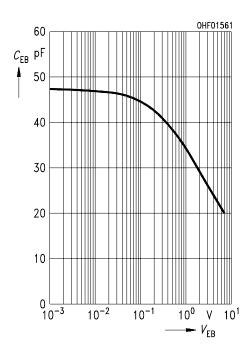
Collector-Emitter Capacitance 2), 3)

 $C_{CE} = f(V_{CE}); f = 1 MHz; E = 0$



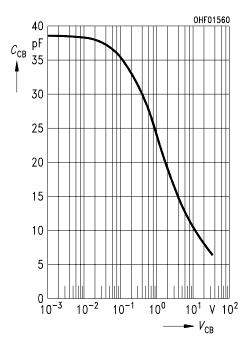
Emitter-Base Capacitance 2), 3)

 $C_{EB} = f(V_{EB}); f = 1 MHz; E = 0;$



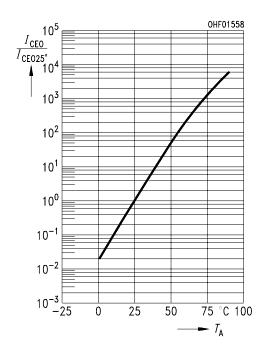
Collector-Base Capacitance 2), 3)

$$C_{CB} = f(V_{CB}); f = 1 MHz; E = 0;$$



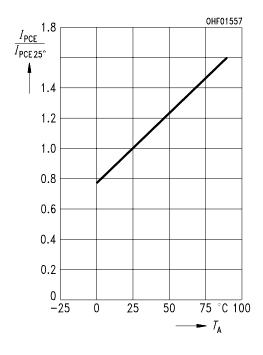
Dark Current 2)

$$I_{CE0,rel} = f(T_A); V_{CE} = 25 \text{ V}; E = 0;$$



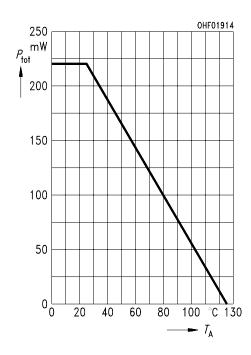
Photocurrent 2)

$$I_{PCE,rel} = f(T_A); V_{CE} = 5 V$$

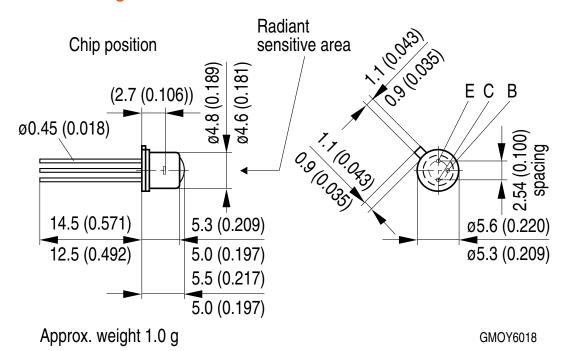


Power Consumption

$$P_{tot} = f(T_A); R_{thJA} = 450 K/W$$



Dimensional Drawing 4)



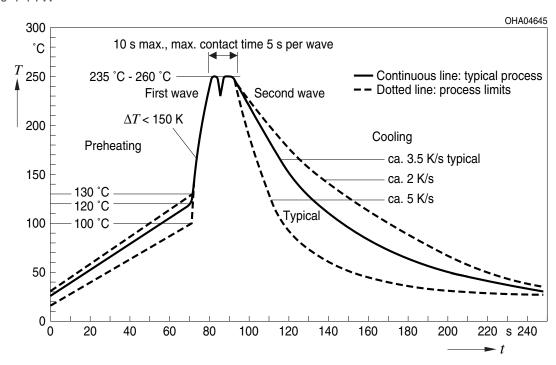
Further Information

Approximate Weight: 332.0 mg



TTW Soldering

IEC-61760-1 TTW





Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class exempt group (exposure time 10000 s). Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes



Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.



Glossary

- 1) **IPCEmin:** IPCEmin is the min. photocurrent of the specified group.
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- ³⁾ **Testing temperature:** TA = 25°C (unless otherwise specified)
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.



Revision History		
Version	Date	Change
1.4	2019-09-13	Characteristics



Published by OSRAM Opto Semiconductors GmbH EU RoHS and China RoHS compliant product Leibnizstraße 4, D-93055 Regensburg www.osram-os.com © All Rights Reserved.

此产品符合欧盟 RoHS 指令的要求;

按照中国的相关法规和标准,不含有毒有害物质或元素。

